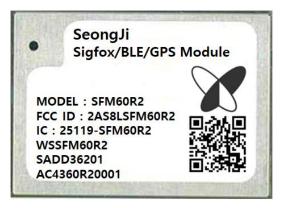
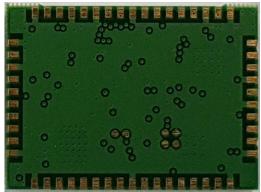
SEONG JI / SFM60R2

DATA SHEET Rev.04





SEONG JI INDUSTRIAL CO.,LTD

54-33, DongtanHana1(i)-gil, Hwaseong-si, Gyeonggi-do, 18423, KOREA

http://www.seongji.co.kr

Sigfox/BLE/GPS module

Revision: 04

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3. Numbering of product	∠
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3-2. Part No	∠
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1. Approval Revision Record

	Povision		Doto	Domark
NO	Revision	RECORD OF REVISION	Date	Remark
1 2	REV 00 REV 01	WSSFM60R2 Initial Releases Hardware connection for RF regulatory certification FCC/IC Warning Statements	2017-08-15 2017-10-12	-
3	REV 02	BLE Support	2018-05-30	-
4	REV 03	Added "ESD Warning"	2018-07-19	-
5	REV 04	Changed manufacture(Wisol → SEONGJI)	2018-08-30	-

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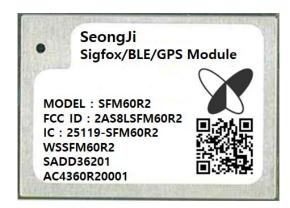
2. Scope

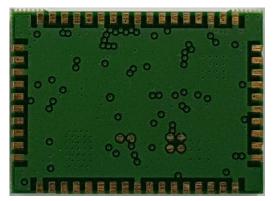
- Description
 - Sigfox Configuration 6 RC2
 - BLE: Support version BT4.2
 - NFC: Type 2 near field communication (NFC-A) tag with wakeup-on-field and touch to-pair capabilities.
 - GPS: Supports GPS and GLONASS.
 - Accelerometer: ±2g/±4g±/8g dynamically selectable full-scale.
- Type : SMD Type
- PBA Size : 29mm(W) x 21mm(L) x 2.3mm(H)

This module has completed SIGFOX P1 verification and FCC, IC RF regulatory certification.

3. Numbering of product

3-1. Product





3-2. Part No.

W	S	S	F	M	6	0	R	2	Α	Р
(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)	(10)	(11)

No.	EXPLANATION
(1),(2)	Wireless Solution
(3),(4)	Application (SF:Sigfox)
(5)	Type (M:Module)
(6),(7)	Group model numbering
(8), (9)	Region Code
(10), (11)	Application Type(Firm Ware Type) AP(API version)



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Sigfox/BLE/GPS module

3-3. Lot. No.

S	A	C	J	A	6	2	0	1
(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)

1	Sigfox M	odule											
2		ture Are king Lo		A Kore			B	V	C				
3	Year Year Mark	2010 W	2011 X	2012 Y	201: Z		14 2	015 B	2016 C	2017 D	2018 E	2019 F	
4	Month Month Mark	1 A	2 B	3 C	4 D	5 E	6 F	7 G		9	10 J	11 K	12 L
(5)	Day Day Mark Day Mark Day Mark Day Mark	1 1 1 1 1 B 21 L	2 2 12 C C 22 M	3 3 13 D 23 N	4 4 14 E 24 O	5 5 15 F 25 P	6 6 16 G Q	7 7 17 H 27	8 7 18 1 7 28	9 9 19 J 29 T	10 A 20 K 30 U	31 V	
67	Model Se	erial Nu	ımber	(10,11,1	12,13.)							
89	A Serial	Numbe	r (1se	rial: 1,1(00ea)								

Sigfox/BLE/GPS module Revision: 04

4. Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
VCC	Module input voltage	5.5	V
ОТ	Operating Temperature	-30 to +85	℃
ST	Storage Temperature	-40 to +125	℃

5. DC Characteristics

Symbol	Parameter	Min	Тур.	Max	Unit
VCC	Module input voltage	3.2	3.3	5.0	٧

6. I/O Specifications

Symbol	Parameter	Min	Тур.	Max	Unit
VCC	supply voltage		3.0	3.3	V
VIH	High level input voltage	2.1			V
VIL	Low level input voltage			0.9	V

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7. RF Specifications

7-1. Sigfox

7-1-1. Electrical Specification

Symbol	Parameter	Min	Тур.	Max	Unit
Current	Tx Current(@MOD)		150		mA
Current	Rx Current		25		mA

7-1-2. Receiver, Transmitter Specification

Conditions: VCC=3.3V, Temp=25 ℃

Parameter		Min	Тур.	Max	Unit
RF Frequency	Тх		902.2		MHz
	Rx		905.2		MHz
Tx output power			22.5		dBm
Frequency Error Tolerance(+25°C)		-2.5	-	+2.5	ppm
2 nd Harmonics(conducted)		-	-37	-35	dBm
3 nd Harmonics(conducted)		-	-41	-35	dBm
Rx Sensitivity(@600bps, GFSK)		-	-129	-	dBm
Rx Spurious Emission(30MHz~12.	75GHz)	-	-	-54	dBm



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Sigfox/BLE/GPS module

7-2. BLE

7-2-1. Electrical Specification

	Parameter	Min	Тур.	Max	Unit	
Target Power for TX						
DI E	Tx mode, Cont.Tx		14		mA	
BLE	Rx mode		13		mA	

7-2-2. Receiver, Transmitter Specification

Conditions: VCC=3.3V, Temp=25 °C

Parameter	Min	Тур.	Max	Unit	
RF Characteristics					
RF Frequency Range		2.402	-	2.480	GHz
Output Power [TRM-LE/CA/01/C]		-0.5	3.5	7.5	dBm
In Band Emission[TRM-LE/CA/03/C] ±2MHz offset ±3MHz offset				-20 -30	dBm
	Delta F1 Avg.	225	-	275	KHz
Modulation Characteristics [TRM-LE/CA/05/C]	Delta F2 Max.	185	-	-	KHz
	Delta F2 Avg/F1 Avg	0.8	-	-	-
	Initial Center Frequency Tolerance	-50	-	50	KHz
	Fn Max.	-150	-	150	KHz
Carrier Frequency Offset and Drift [TRM-LE/CA/06/C]	F0 -Fn Max.	-	-	50	KHz
	F1 – F0	-	-	20	KHz
	Fn = Fn-5 max.	-	-	20	KHz
Receiver Sensitivity [PER<30.8%, 1	-	-93.5	-70	dBm	
Maximum input lever [PER<30.8%,	1500packets]	-10	0		dBm

Sigfox/BLE/GPS module Revision: 04

7-3. GPS

7-3-1. Module Specification

Conditions: VCC=3.3V, Temp=25 °C

Odnations. VOO=0.0 V, Tomp=20 O	_
Frequency	L1, 1575.42MHz
GPS Sensitivity	
Tracking	-158 dBm
Navigation	-157 dBm
Acquisition (Cold start)	-143 dBm
C/N0 ²	- 37
Time To First Fix ²	
Hot Start	< 1s
Cold Start	< 35s

7-3-2. EVB Specification

-With external GPS LNA module(SAW filter + LNA)

With external of a Franchical (C) (W little Franchical C)	/
Frequency	L1, 1575.42MHz
GPS Sensitivity ¹	
Tracking	-160 dBm
Navigation	-159 dBm
Acquisition (Cold start)	-145 dBm
C/N0 ²	- 39
Time To First Fix ²	
Hot Start	< 1s
Cold Start	< 35s

¹ Demonstrated with a SFMG2XAB002 (SAW+LNA) ² All satellites at -130 dBm

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Sigfox/BLE/GPS module

7-4. NFC

7-4-1. Electrical Specification

Parameter	Min	Тур.	Max	Unit
RF Input Frequency		13.56		MHz
ISO-14443A	·			
Carrier modulation index	95			%
Data Rate		106		Kbps
Modulation sub carrier frequency		13.56 /16		MHz
NFC Reader	Min	Тур.	Max	Unit
ACR122U (ACS) ¹ reading range	40			mm
Dragon (DUAL I) ² reading range	50			mm

^{1.}Measurement NFC reader

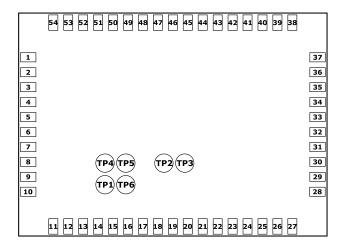
¹ACR122U: http://www.acs.com.hk/en/products/3/acr122u-usb-nfc-reader/ ²Dragon: http://duali.com/eng/nfc-product/nfc-reader/nfc-desktop-readers.html

^{2.} Demonstrated with a reference antenna included in the EVK.

Sigfox/BLE/GPS module Revision: 04

8. Pin Description

8-1. Interface PIN(SMD Type: 60 Pin) Top view



NO	PIN NAME	NO	PIN NAME	NO	PIN NAME
1	NC	22	I2C0_SCL_DBG	43	GND
2	NC	23	STATE0	44	NFC2
3	GPIO0	24	WKUP	45	NFC1
4	GND	25	STATE_CPU_SFX	46	GND
5	GPS_RF	26	STATE_RF_SFX	47	GPIO1
6	GND	27	GND	48	GPIO2
7	VDD_MAIN_3P0	28	GND	49	NC
8	V_BCKP_GPS	29	VDD_SFX_EN	50	NC
9	VDD_GPS	30	NRST_SFX	51	NC
10	GND	31	SWDCLK	52	GND
11	GND	32	SWDIO	53	NC
12	NRST_GPS	33	VDD_SFX	54	GND
13	I2C1_SDA_ACC	34	NRST	TP1	NC (VDD USB For GPS)
14	I2C1_SCL_ACC	35	GND	TP2	NC (USB DM For GPS)
15	I2C1_SCL_BLE	36	SIGFOX_RF	TP3	NC (USB DP For GPS)
16	I2C_SDA_BLE	37	GND	TP4	NC (GND for GPS)
17	VDD_GPS_EN	38	GND	TP5	NC
18	BATT	39	AIN1	TP6	NC
19	GND	40	AIN0		
20	2ND_POW_EN	41	GND		
21	I2C0_SDA_DBG	42	BLE_RF		

^{*} In case of RF regulatory certification, connect to external connector or Test-point to download test firmware. For details, refer to "8-2-1 Hardware connection for RF Regulatory Certification".



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Sigfox/BLE/GPS module

8-2. Interface PIN description

NO.	PIN NAME	TYPE	DESCRIPTION
1	NC		No connection should be made to this pin
2	NC		No connection should be made to this pin
3	GPIO0	I/O	General Purpose Input Output
4,6,10,11,19, 27,28,35,37,38,	GND	Р	Ground
41,43,46,52,54			
5	GPS_RF	RF	GPS RF Input
7	VDD_MAIN_3P0	P/O	3.0V Main power
8	V_BCKP_GPS	P/I	GPS backup power
9	VDD_GPS	P/O	GPS Power
12	NRST_GPS	I	GPS Reset , do not connect
13	I2C1_SDA_ACC*		Accelerometer Side, connect pin16(I2C1_SDA_BLE)
14	I2C1_SCL_ACC*		Accelerometer Side, connect pin15(I2C1_SCL_BLE)
15	I2C1_SCL_BLE*		BLE(CPU) Side, connect to pin14(I2C1_SCL_ACC)
16	I2C1_SDA_BLE*		BLE(CPU) Side, connect to pin13(I2C1_SDA_ACC)
17	VDD_GPS_EN	0	GPS power enable
18	BATT	P/I	Supply 3.3V ~ 5.0V
20	2ND_POW_EN	0	Secondary DCDC power enable
			Module Debugging port for I2C.
21	I2C0_SDA_DBG		It must be connected to an external connector or TP for use in RF regulatory certifications.
22	I2C0_SCL_DBG		Module Debugging port for I2C. It must be connected to an external connector or TP for use in RF regulatory certifications.
23	STATE0	0	Indicate module(BLE) state
24	WKUP	I	Module Wake-up from sleep state
25	STATE_CPU_SFX	0	Sigfox CPU state
26	STATE_RF_SFX	0	Sigfox RF state
29	VDD_SFX_EN	0	Sigfox power enable
30	NRST_SFX	I	Sigfox Reset , do not connect
31	SWDCLK	I	BLE SWD clock input for debug and programming. It must be connected to an external connector or TP for use in RF regulatory certifications.
32	SWDIO	I/O	BLE SWD I/O for debug and programming. It must be connected to an external connector or TP for use in RF regulatory certifications.
33	VDD_SFX	P/O	Sigfox Power output



Sigfox/BLE/GPS module

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36	SIGFOX_RF	RF	Sigfox RF In/Out	
39	AIN1	I/O	Analog input, General purpose I/O	
40	AIN0	I/O	Analog input, General purpose I/O	
42	BLE_RF	RF	BLE RF In/Out	
44	NFC2	I/O	NFC antenna connection , General purpose I/O	
45	NFC1	I/O	NFC antenna connection , General purpose I/O	
47	GPIO1	I/O	General Purpose Input Output	
48	GPIO2	I/O	General Purpose Input Output	
49	NC		No connection should be made to this pin	
50	NC		No connection should be made to this pin	
51	NC		No connection should be made to this pin	
53	NC		No connection should be made to this pin	
TP1	NC		Internal connection	
TP2	NC		Internal connection	
TP3	NC		Internal connection	
TP4	NC		Internal connection	
TP5	NC		Internal connection	
TP6	NC		Internal connection	

- To use internal accelerometer sensor, connect pin 13 to pin 16 and pin 14 to pin 15.
- Slave address of internal accelerometer is 0x18(7bit)
- External I²C devices can be connected to pin 15 and 16.

8-2-1. Hardware connection for RF Regulatory Certification

When performing RF certification on products using the SFM60R module, you must have the following hardware connections to control each RF block and download the test-firmware.

- Sigfox, BLE, GPS control

There is no need to download a test-firmware and one of the two below must be connected to an external connector or test-point to control the RF block.

[Case 1]

The SWD(pin31 and pin32) port can be used to control Sigfox, BLE and GPS. However, JTAG equipment such as J-link is required.

[Case 2]

The I2C(pin21 and pin22) port can be used to control Sigfox, BLE and GPS. However, I2C to USB converter is required.

8-2-2. Sigfox status PIN

STATE_CPU_SFX : Sigfox CPU activity indicator
 STATE_RF_SFX : Sigfox Radio activity indicator

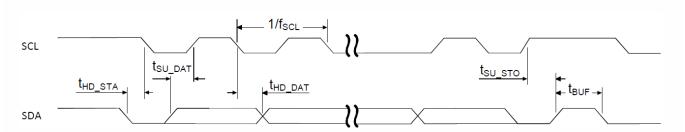
8-2-3. I2C Master for external sensors

The TWI master is compatible with I2C operating at 100 kHz and 400 kHz.

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Sigfox/BLE/GPS module

Symbol	Description	Min.	Тур.	Max.	Units
f⊤wı,SCL,100k	SCL clock frequency, 100 kbps		100		kHz
f _{TWI} ,SCL,400k	SCL clock frequency, 400 kbps		400		kHz
tтwi,SU_DAT	Data setup time before positive edge on SCL – all modes	300			ns
tтwi,HD_DAT	Data hold time after negative edge on SCL – all modes	500			ns
tтwi,HD_STA,100k	TWI master hold time for START and repeated START condition, 100k	10000			ns
tтwi,HD_STA,400k	TWI master hold time for START and repeated START condition, 400k	2500			ns
tтwi,SU_STO,100k	TWI master setup time from SCL high to STOP condition, 100k	5000			ns
tтwi,SU_STO,400k	TWI master setup time from SCL high to STOP condition, 400k	1250			ns
tтwi,BUF,100k	TWI master bus free time between STOP and START conditions, 100k	5800			ns
tтwi,BUF,400k	TWI master bus free time between STOP and START conditions, 400k	2100			ns



TWI timing diagram, 1 byte transaction

8-2-4. I2C Slave for debug

upto 400Khz

8-2-5. Two-pin Serial Wire Debug (SWD) interface

- The debug and trace system offers a flexible and powerful mechanism for non-intrusive debugging. The main features of the debug and trace system are:
 - . Two-pin Serial Wire Debug (SWD) interface
 - . Flash Patch and Breakpoint Unit (FPB) supports:
 - . Two literal comparators
 - . Six instruction comparators
 - . Data Watchpoint and Trace Unit (DWT)
 - . Four comparators
 - . Instrumentation Trace Macrocell (ITM)
 - . Embedded Trace Macrocell (ETM)

8-2-6. GPIOs

support 7 GPIO

STATE0

WKUP

AIN1

AIN0

GPIO0

GPIO1

GPIO2

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* GPIO01 is used as bootstrap pin. Do not connect to GND.

8-2-7. NFC

• Type 2 near field communication (NFC-A) tag with wakeup-on-field and touch to-pair capabilities

8-2-8. Reset Pin

• Chip reset input. Active low.

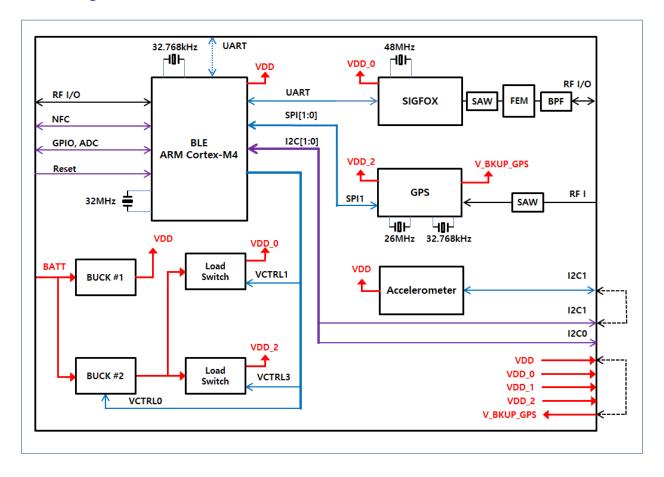
Sigfox/BLE/GPS module Revision: 04

8-3. SFM60R and SFM20R Pin Comparison Table

NO	SFM60R- Pin Name	SFM20R- Pin Name	NO	SFM60R- Pin Name	SFM20R- Pin Name
1	NC	STATE_LINK_WIFI	31	SWDCLK	SWDCLK
2	NC	STATE_WORK_WIFI	32	SWDIO	SWDIO
3	GPIO0	VDD_WIFI_EN	33	VDD_SFX	VDD_SFX
4	GND	GND	34	NRST	NRST
5	GPS_RF	GPS_RF	35	GND	GND
6	GND	GND	36	SIGFOX_RF	SIGFOX_RF
7	VDD_MAIN_3P0	VDD_MAIN_3P0	37	GND	GND
8	V_BCKP_GPS	V_BCKP_GPS	38	GND	GND
9	VDD_GPS	VDD_GPS	39	AIN1	AIN1
10	GND	GND	40	AIN0	AIN0
11	GND	GND	41	GND	GND
12	NRST_GPS	NRST_GPS	42	BLE_RF	BLE_RF
13	I2C1_SDA_ACC	I2C1_SDA_ACC	43	GND	GND
14	I2C1_SCL_ACC	I2C1_SCL_ACC	44	NFC2	NFC2
15	I2C1_SCL_BLE	I2C1_SCL_BLE	45	NFC1	NFC1
16	I2C_SDA_BLE	I2C_SDA_BLE	46	GND	GND
17	VDD_GPS_EN	VDD_GPS_EN	47	GPIO1	DL_EN/INT_WIFI
18	BATT	BATT	48	GPIO2	NRST_WIFI
19	GND	GND	49	NC	UART0_RX_WIFI
20	2ND_POW_EN	2ND_POW_EN	50	NC	UART0_TX_WIFI
21	I2C0_SDA_DBG	I2C0_SDA_DBG	51	NC	VDD_WIFI
22	I2C0_SCL_DBG	I2C0_SCL_DBG	52	GND	GND
23	STATE0	STATE0	53	NC	WIFI_RF
24	WKUP	WKUP	54	GND	GND
25	STATE_CPU_SFX	STATE_CPU_SFX	TP1	NC (VDD USB For GPS)	NC (VDD USB For GPS)
26	STATE_RF_SFX	STATE_RF_SFX	TP2	NC (USB DM For GPS)	NC (USB DM For GPS)
27	GND	GND	TP3	NC (USB DP For GPS)	NC (USB DP For GPS)
28	GND	GND	TP4	NC (GND for GPS)	NC (GND for GPS)
29	VDD_SFX_EN	VDD_SFX_EN	TP5	NC	NC
30	NRST_SFX	NRST_SFX	TP6	NC	NC

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9. Block Diagram





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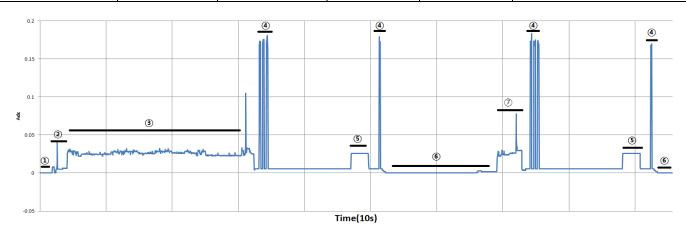
10. Power Modes

10-1. Test condition

Time Interval : 40ms Measurement : DC Current

Range(Adc): 1A

Power Off	Power On	GPS (ublox)		Sleep	
(DeepSleep)	Tower on	G. 5 (d.5.6%)	Тх	Rx	* use V_BCKP_GPS : 15uA
average 5uA	average 4mA	average 23mA	average	average	average 40uA
average 3uA	average 4111A	average 23111A	155mA	23mA	average 400A
1	2	3 7	4	(5)	6



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11. FCC/IC Warning Statements

FCC Part 15.19 / RSS-GEN Sec.8.4 Statements:

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes :

- (1) l'appareil ne doit pas produire de brouillage, et
- (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

FCC Part 15.21 statement

Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

RF Exposure Statement

The antenna(s) must be installed such that a minimum separation distance of at least 20 cm is maintained between the radiator (antenna) and all persons at all times. This device must not be co-located or operating in conjunction with any other antenna or transmitter.

l'exposition aux RF L'antenne (ou les antennes) doit être installée de façon à maintenir à tout instant une distance minimum de au moins 20 cm entre la source de radiation (l'antenne) et toute personne physique.

End Product Labeling

The module is labeled with its own FCC ID. If the FCC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. In that case, the final end product must be labeled in a visible area with the following:

"Contains FCC ID: 2AS8LSFM60R2

"Contains IC: 25119-SFM60R2

Étiquetage du produit final Le module BT111 est étiqueté avec sa propre identification FCC et son propre numéro de certification IC. Si l'identification FCC et le numéro de certification IC ne sont pas visibles lorsque le module est installé à l'intérieur d'un autre dispositif, la partie externe du dispositif dans lequel le module est installé devra également présenter une étiquette faisant référence au module inclus. Dans ce cas, le produit final devra être étiqueté sur une zone visible avec les informations suivantes :

- « Contient module émetteur identification FCC ID : 2AS8LSFM60R2
- « Contient module émetteur IC : 25119-SFM60R2

OEM Responsibilities to comply with FCC Regulations

The module has been certified for integration into products only by OEM integrators under the following condition:

- The antenna(s) must be installed such that a minimum separation distance of at least 20cm is maintained between the radiator (antenna) and all persons at all times.
- The transmitter module must not be co-located or operating in conjunction with any other antenna or transmitter except in accordance with FCC multi-transmitter product procedures.

As long as the two conditions above is met, further transmitter testing may not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

IMPORTANT NOTE: In the event that these conditions can't be met (for certain configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID can't be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product(including the transmitter) and obtaining a separate FCC authorization.

Manual Information To the End User

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove

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this RF module or change RF related parameters in the user manual of the end product.

RSS-GEN, Sec. 8.3

This radio transmitter (IC: 25119-SFM60R2, Model: SFM60R2) has been approved by Innovation, Science and Economic Development Canada to operate with the antenna types listed below with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

- List of approved antennas

- 1) For Sigfox antenna, INNO-EL9SWS-149 or similar part manufactured by Inno-Link. Co., Ltd. (Highest permitted antenna gain: 2.01 dBi)
- 2) For Wi-Fi 2.4 GHz antenna, INNO-EL9SWS-151 or similar part manufactured by Inno-Link. Co., Ltd. (Highest permitted antenna gain: 4.15 dBi)
- 3) For BT LE antenna, INNO-EL9SWS-151 or similar part manufactured by Inno-Link. Co., Ltd.(Highest permitted antenna gain: 4.15 dBi)

Le présent émetteur radio (IC: 25119-SFM60R2, Model: SFM60R2) a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés ci-dessous et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

- Liste des antennes approuvées

- 1) Pour l'antenne Sigfox, INNO-EL9SWS-149 ou une pièce similaire fabriquée par Inno-Link. Co., Ltd. (Plus haut gain d'antenne autorisé: 2,01 dBi)
- 2) Pour antenne Wi-Fi 2,4 GHz, INNO-EL9SWS-151 ou une pièce similaire fabriquée par Inno-Link. Co., Ltd. (Plus haut gain d'antenne autorisé: 4.15 dBi)
- 3) Pour l'antenne BT LE, INNO-EL9SWS-151 ou une pièce similaire fabriquée par Inno-Link. Co., Ltd. (Plus haut gain d'antenne autorisé: 4.15 dBi)

Antenna Installation Requirement

The host manufacturer must meet the antenna requirements stated in operational description and must not give to access to antenna connector to user when you install this module into devices to be compliance with FCC section 15.203.

Antenna Trace Design for Host devices

- a) Trace layout and dimensions including specific designs for each type:
- 1) Layout of trace design, parts, antenna, connectors, and isolation requirements;
- → All RF trace must be 50 ohm line. Connectors are required to use SMA Type connector. And Antenna is required to use dipole antenna manufactured by Inno-Link. Co., Ltd..

But, you must not give to access to antenna connector to user when you install this module into devices to be compliance with FCC section 15.203.

- 2) Boundary limits of size, thickness, length, width, shape(s), dielectric constant, and impedance must be clearly described for each type of antenna;
- → Antenna should be used only SMA type antenna manufactured by Inno-Link Co., Ltd.. Different antenna type is not acceptable.
- 3) Different antenna length and shapes affect radiated emissions, and each design shall be considered a different type; e.g., antenna length in multiple(s) of frequency wavelength and antenna shape (traces in phase) can affect antenna gain and must be considered;
- → Different antenna is unacceptable.

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b) Appropriate parts by manufacturer and specifications.

- 1) For Sigfox antenna, INNO-EL9SWS-149 or similar part manufactured by Inno-Link. Co., Ltd.
- 2) For Wi-Fi 2.4 GHz antenna, INNO-EL9SWS-151 or similar part manufactured by Inno-Link. Co., Ltd.
- 3) For BT LE antenna, INNO-EL9SWS-151 or similar part manufactured by Inno-Link. Co., Ltd.

c) Test procedures for design verification.

The manufacturer should verify that the antenna trace design on the PCB board is compliance with this Antenna Trace Design documents.

You connect the antenna connector of the device to the input of a measurement instrument. And you set the measurement instrument to the proper options for each frequency bands and conduct the test to get the output power from the antenna connector. The permissible output power range is in below table to verify the antenna trace design is appropriate for this document.

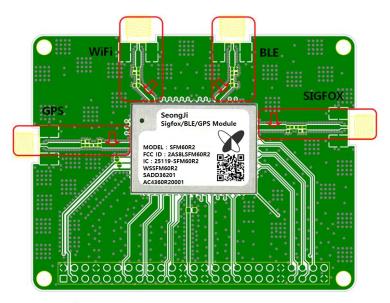
Band	Output power	Tolerance
WIFi	19.5 dBm	+/- 2.5 dB
Sigfox	22.1385 dBm	+/- 1.5 dB
BT LE	3.48 dBm	+/- 4.0 dB

d) Production test procedures for ensuring compliance.

The host product itself is required to comply with all other applicable FCC equipment authorization regulations, requirements.

So, the host device should be tested for unintentional radiators under Part 15 subpart B for non-transmitter functions on the transmitter module as appropriate.

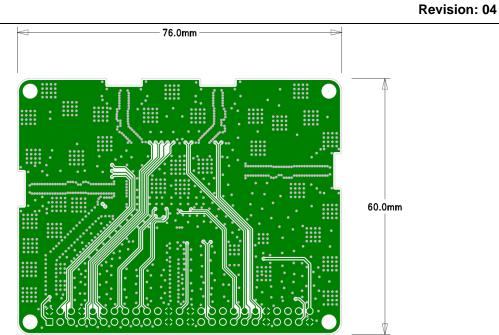
4) The above data is to be provided by a Gerber file (or equivalent) for PCB layout.



: 50 ohm matching pattern

[PCB Top]

Sigfox/BLE/GPS module



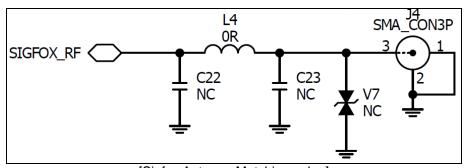
[PCB Bottom]

[Antenna application PCB information]

PCB Thickness: 1.6mm

Impedance line width: 1.2mm

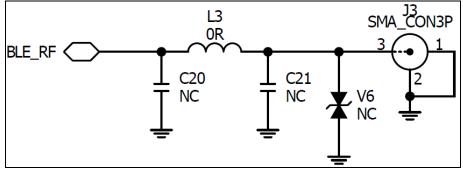
Clearance : 0.2mm FR4 PCB ϵ_r = 4.6



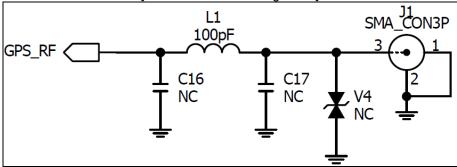
[WiFi Antenna matching value]

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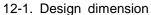
[BLE Antenna matching value]

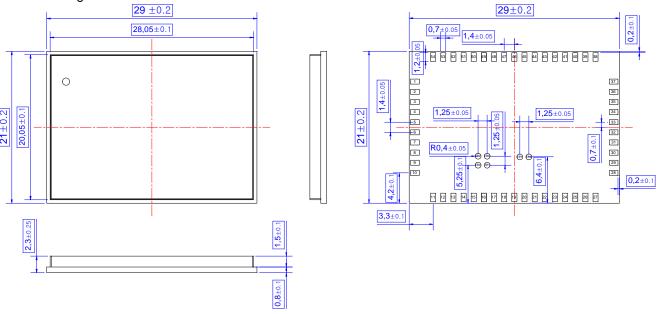


[GPS Antenna matching value]

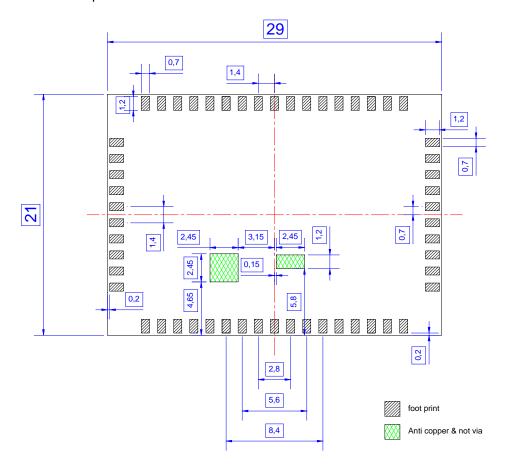
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12. Dimensions & drawing





12-2. Recommend Foot print

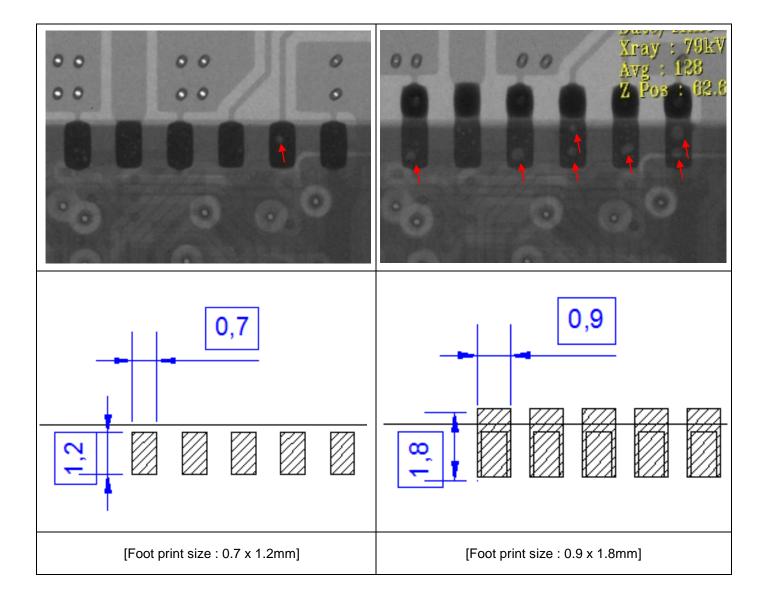


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- X-ray by Foot print size

The foot print size was designed 0.7x1.2mm and 0.9x1.8mm then the SMD was performed.

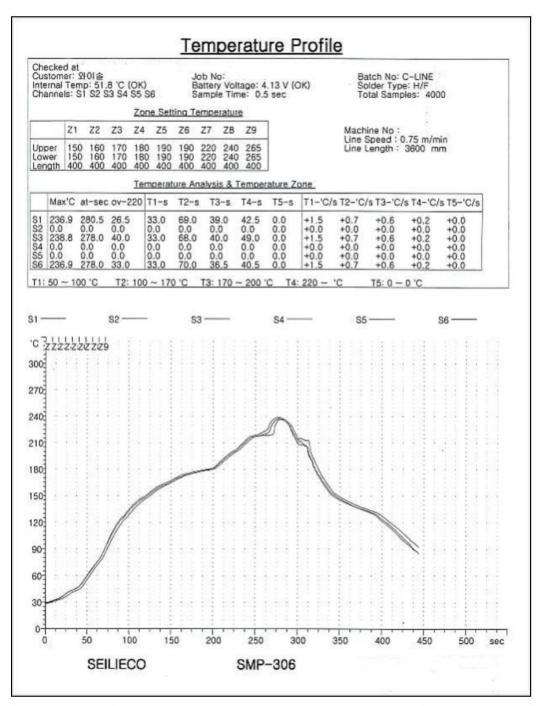
It is not a big difference, but it can be seen that the design with 0.7x1.2mm has better soldering performance with less Void as seen in the X-ray below. The disadvantage is that manual soldering is not possible, so it may be better to design 0.9x1.8mm for development stage. However, we recommend a foot print of 0.7 x 1.2mm for mass production.



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13. Reflow profile

<Reflow profile of Module>

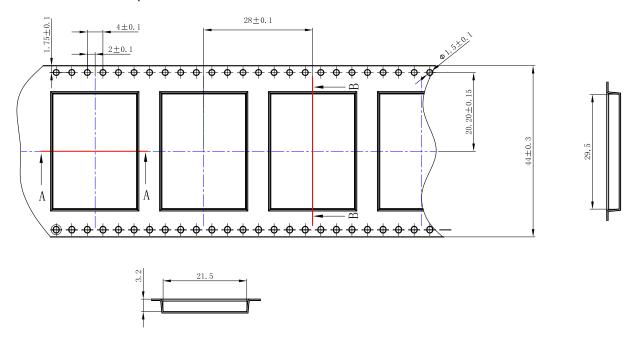


	Preheat	Soak	Ramp	PEAK
SPEC	50~100°C	100~170°C	220℃ ↑	240°C
	1~2°C/sec	60~100sec	30~50sec	±5℃
result of measurement	1.5	69	44	237.5
	ОК	ОК	ОК	OK

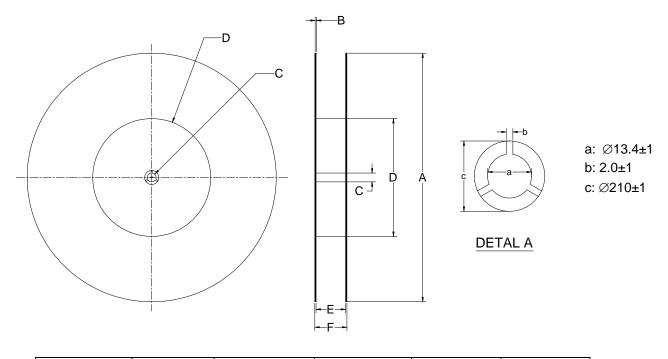
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14. Package

14-1. Dimension of Tape



14-2. Dimension of Reel



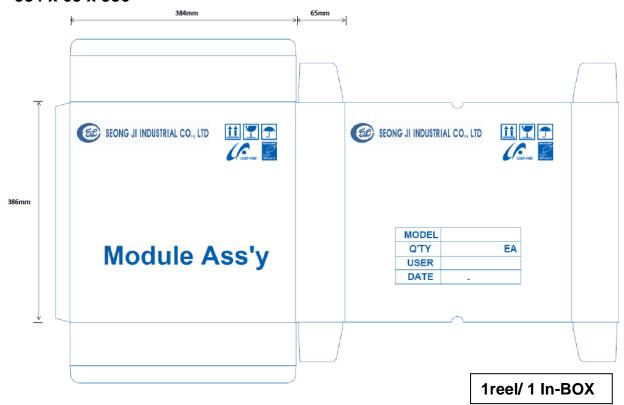
Α	В	С	D	E	F
380 ± 1 mm	2 ± 1 mm	13.4 ± 1 mm	180 ± 1 mm	45 ± 1 mm	49 ± 1 mm



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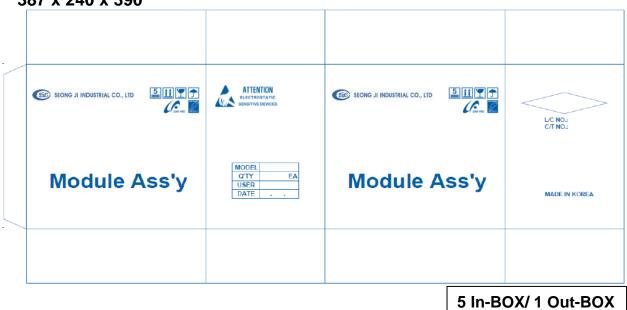
14-3. IN BOX

384 x 65 x 386



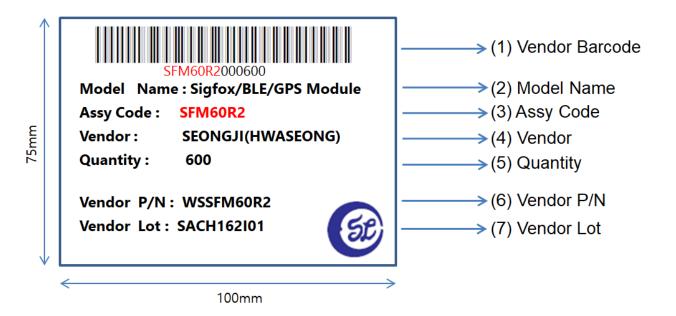
14-4. OUT BOX

387 x 240 x 390

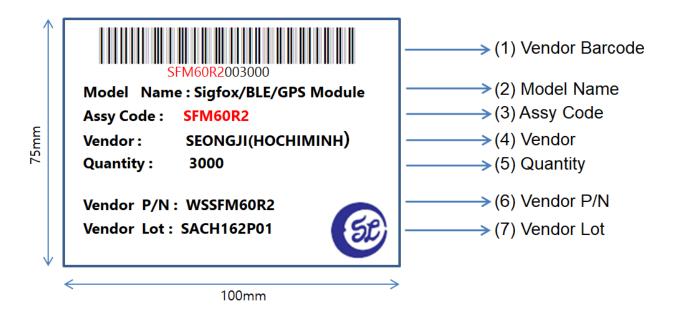


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14-5. IN BOX Label



14-6. OUT BOX Label



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ESD Warning



This modules are ESD sensitive devices, appropriate precautions should be taken during the module assembly in the final product.

Mechanical impact and harsh tools must be avoided during the module assembly in the final product.

Product ESD specification:

HBM ±2kV

The following precautions must be taken:

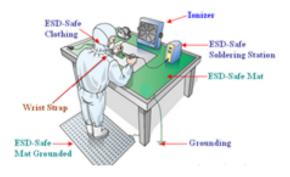
 Do not open the protective conductive packaging until you have use the following, and are at an approved anti-static work station.





 Use a conductive wrist strap attached to a good earth ground.

- If working on a prototyping board, use a soldering iron or station that is marked as ESD-safe.
- If possible, use SMT equipment(reflow) when making prototype boards.
- Use an approved anti-static mat to cover your work surface.





 Always discharge yourself by touching a grounded bare metal surface or approved anti-static mat before picking up an ESD - sensitive electronic component.